DESCRIPTION This document describes the

This document describes the specification for the F1951 Digital Step Attenuator. The F1951 is part of a family of *Glitch-Free*TM DSAs optimized for the demanding requirements of communications Infrastructure. These devices are offered in a compact 4x4 QFN package with 50 Ω impedances for ease of integration into the radio system.

COMPETITIVE ADVANTAGE

Digital step attenuators are used in Receivers and Transmitters to provide gain control. The F1951 is a 6bit step attenuator optimized for these demanding applications. The silicon design has very low insertion loss and low distortion (+65 dBm IP3₁.). The device has pinpoint accuracy and settles to final attenuation value within 400 nsec. Most importantly, the F1951 includes Renesas' *Glitch-Free*TM technology which results in less than 0.6 dB of overshoot ringing during MSB transitions. This is in stark contrast to competing DSAs that *glitch as much as 10 dB* during MSB transitions (see p.10).

- ✓ Lowest insertion loss for best SNR
- ✓ Glitch-Free[™] when transitioning won't damage PA or ADC
- Extremely accurate with low distortion

APPLICATIONS

- Base Station 2G, 3G, 4G, TDD radiocards
- Repeaters and E911 systems
- Digital Pre-Distortion
- Point to Point Infrastructure
- Public Safety Infrastructure
- WIMAX Receivers and Transmitters
- Military Systems, JTRS radios
- RFID handheld and portable readers
- Cable Infrastructure

Part# Matrix

| Part# | Freq range Resolution / (MHz) Range (dB) Control | | IL (dB) | Pinout | |
|-------|---|-------------|-------------|--------|------|
| F1951 | 100 - 5000 | 0.50 / 31.5 | Serial Only | -1.2 | нітт |
| F1950 | 150 - 5000 | 0.25 / 31.5 | Serial Only | -1.3 | PE |
| F1952 | 100 - 4000 | 0.50 / 15.5 | Serial Only | -0.9 | HITT |

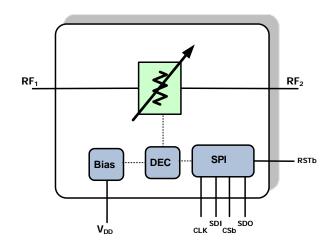
FEATURES

6-bit 0.5 dB Digital Step Attenuator

100MHz to 5000MHz

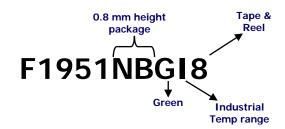
- *Glitch-Free*TM, < 0.6 dB transient overshoot
- Spurious Free Design
- 3 V to 5.25 V supply
- Attenuation Error < 0.2 dB @ 2 GHz
- Low Insertion Loss < 1.2 dB @ 2 GHz
- Excellent Linearity +65 dBm IP3₁
- Fast settling time, < 450 ns
- Class 2 JEDEC ESD (> 2kV HBM)
- Serial Interface 31.5 dB Range
- Stable Integral Non-Linearity over temperature
- 4x4 mm Thin QFN 24 pin package

BLOCK DIAGRAM



ORDERING INFORMATION

1





RENESAS



ABSOLUTE MAXIMUM RATINGS

 $\begin{array}{l} V_{DD} \text{ to GND} \\ D[5:0], \text{ DATA, CLK, CSb, SDO, RSTb} \\ \text{RF Input Power (RF1, RF2) calibration and testing} \\ \text{RF Input Power (RF1, RF2) continuous RF operation} \\ \theta_{JA} (Junction - Ambient) \\ \theta_{JC} (Junction - Case) \text{ The Case is defined as the exposed paddle} \\ \text{Operating Temperature Range (Case Temperature)} \\ \text{Maximum Junction Temperature} \\ \text{Storage Temperature Range} \\ \text{Lead Temperature (soldering, 10s)} \end{array}$

-0.3 V to +5.50V -0.3 V to 3.6 V +29 dBm +23 dBm +50 °C/W +3 °C/W T_c = -40 °C to +100°C 140 °C -65 °C to +150 °C +260 °C

F1951 SPECIFICATION (31.5 dB Range)

Specifications apply at V_{DD} = +3.3V, f_{RF} = 2000MHz, T_C= +25°C unless otherwise noted, EVKit losses are de-embedded (see p. 17)

| Parameter | Comment | Sym. | Min | Typical | Max | Units | |
|--|---|--------------------------|---------------------------|---------|--------------------|--------|--|
| Logic Input High CLK, CSb, DATA, D[5:0], RSTb | | VIH | 2.3 ^[a] | | 3.6 ^[b] | V | |
| Logic Input Low | CLK, CSb, DATA, D[5:0], RSTb | VIL | | | 0.7 | V | |
| Logic Current | V _{MODE} | Іін, Іі∟ | -5 | | +5 | μA | |
| Supply Voltage(s) | Main Supply | V _{DD} | 3.0 | | 5.25 | V | |
| Supply Current | Total | IDD | | 1.1 | 2 | mA | |
| Temperature Range | Operating Range (Case) | Tc | -40 | | 100 | °C | |
| Frequency Range | Operating Range | f _{RF} | 100 | | 5000 | MHz | |
| RF1, RF2 Return Loss | dB(s11), dB(s22) | S 11, S 22 | | -22 | | dB | |
| Minimum Attenuation | D[5:0] = [111111] | Amin or IL | | 1.2 | 1.9 | dB | |
| Maximum Attenuation | D[5:0] = [000000] V_{DD} = 3.3V | Амах | 32.2 | 32.5 | | dB | |
| Minimum Gain Step | Least Significant Bit | LSB | | 0.50 | | dB | |
| Phase Delta | Phase change A _{MIN} vs. A _{MAX} | ΦΔ | | 33 | | deg | |
| Differential Non-Linearity | Error: adjacent steps | DNL | | 0.08 | | dB | |
| Integral Non-Linearity | Error: absolute to 14 dB ATTN | INL ₁ | | 0.03 | 0.34 | dB | |
| Integral Non-Linearity | Max Error vs. line (A_{MIN} ref) to 31.5 dB ATTN [V_{DD} = 3.3V] | INL ₂ | | 0.21 | 0.38 | dB | |
| | P_{IN} = +10 dBm per tone 50 MHz Tone Separation V_{DD} = 3.3V | | | | | dBm | |
| Input IP3 | D[5:0] = [111111] = A _{MIN} | IP3I₁ | +61 | +64 | | | |
| | D[5:0] = [100000] = A _{15.5} | IP3I ₂ | +59 | +61 | | | |
| | D[5:0] = [000000] = A _{MAX} | IP3I ₃ | +57 | +61 | | | |
| 0.1 dB Compression Please note ABS MAX | D[5:0] = [111010] = A_{2.5} Baseline P_{IN} = 20 dBm | P _{0.1} | | 29 | | dBm | |
| Settling Time | Start LE rising edge > V_H End +/-0.10 dB Pout settling 15.5 - 16.0 transition | Tlsb | | 400 | | ns | |
| Serial Clock Speed | SPI 4 wire bus | Fclk | | 20 | 50 | MHz | |
| Reset to Serial Setup | SPI 4 wire bus | A | 20 | | | ns | |
| Serial Data Hold Time | SPI 4 wire bus | В | 5 | | | ns | |
| CSb setup delay | SPI 4 wire bus | C | 40 | | | ns | |
| Serial Data Out Delay | SPI 4 wire bus | D | 8 | 8 | 8 | Cycles | |

[a] - Items in min/max columns in *bold italics* are Guaranteed by Test.

[b] – All other Items in min/max columns are Guaranteed by Design Characterization.

SERIAL CONTROL MODE

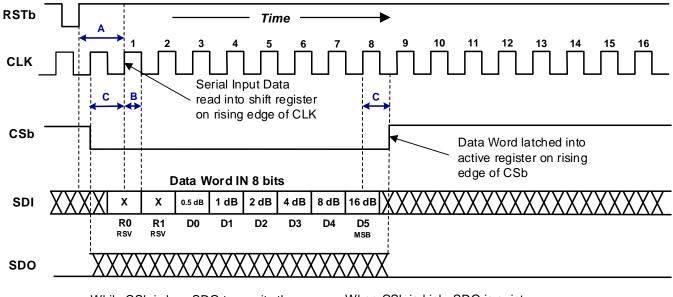
RENESAS

Data is clocked in LSB first via serial mode. Note the timing diagram below.

An RSTb pulse resets the shift register to [0000000]. If the RSTb pulse is followed immediately by a CSb pulse the device will be set to <u>Maximum Attenuation</u>.

Note – The F1951 includes a CLK inhibit feature designed to minimize sensitivity to CLK bus noise when the device is not being programmed. When CSb is high (> V_{IH}), the CLK input is disabled and serial data (SDI) will not be clocked into the shift register. It is recommended that CSb be pulled high (> V_{IH}) when the device is not being programmed

SERIAL REGISTER TIMING DIAGRAM [SINGLE DEVICE]: (Note the Timing Spec Intervals in Blue)



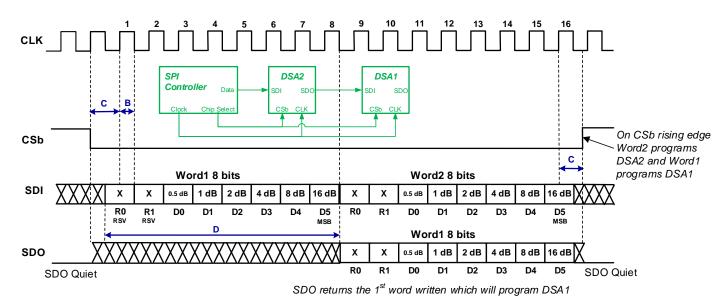
While CSb is low, SDO transmits the contents of the shift register delayed by 8 clock cycles

When CSb is high, SDO is quiet

SERIAL REGISTER TIMING DIAGRAM [TWO OR MORE DEVICES]:

RENESAS

The SDO output is delayed by 8 clock cycles while CSb is low. The SDO low logic voltage is 0 volts and the SDO high logic voltage is VDD/2. This feature allows one to program multiple DSAs (in a MIMO transceiver for instance) with a single common CSb line by daisy-chaining the SDO of the 2nd DSA to the SDI of the 1st DSA and so forth:



SERIAL REGISTER DEFAULT CONDITION [F1951]:

When the device is first powered up, it will default to the <u>Maximum Attenuation</u> setting as described below: Note that for the F1951 (High or 1) = Attenuation Stepped <u>OUT</u>. (0 or Low) = Attenuation Stepped <u>IN</u>.

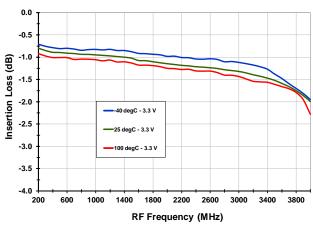
Default Register Settings

| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
|---|-----------|-----------|-----------|----|----|----|----|-----------|
| - | R0 RSV | R1 RSV | D0 LSB | D1 | D2 | D3 | D4 | D5 MSB |

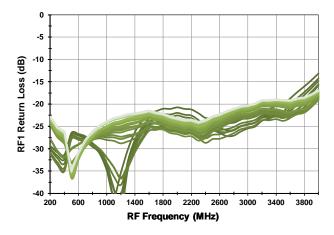
SERIAL REGISTER TIMING TABLE [F1951]:

| Interval Symbol | Description | Min Spec | Max Spec | Units | |
|--------------------|----------------------------|-------------|-------------|--------|--|
| Α | Reset to Serial Setup Time | 20 | | ns | |
| B | Serial Data Hold Time | 5 | | ns | |
| С | CSb setup delay | 40 | | ns | |
| D | Serial Data Out Delay | 8 | 8 | Cycles | |

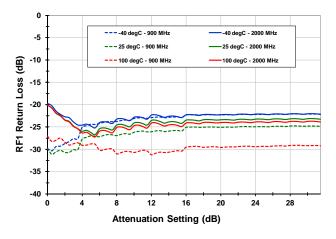
TYPICAL OPERATING PARAMETRIC CURVES (EVKit loss de-embedded, 3.3V unless otherwise noted)



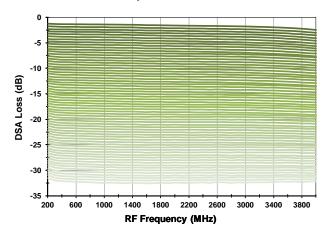
S₁₁ vs. Frequency [T_{CASE} = +25C, 0.5 dB steps]



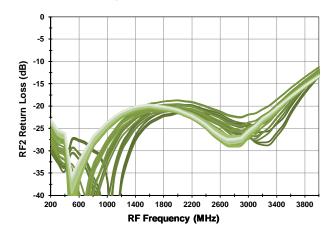
S₁₁ vs. Attenuation State



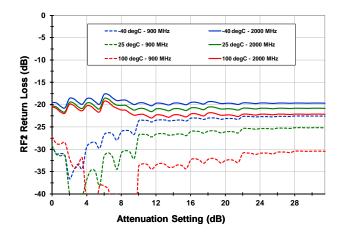
Attenuation vs. Freq [T_{CASE} = +25C, 0.5 dB steps]



S₂₂ vs. Frequency [T_{CASE} = +25C, 0.5 dB steps]



S22 vs. Attenuation State



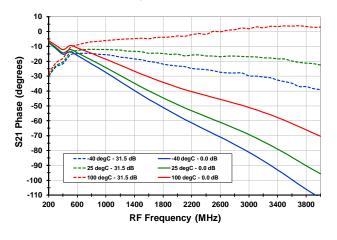
Insertion Loss vs. Frequency [Amin]

RENESAS

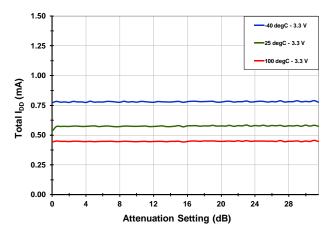


TOCs CONTINUED (-2-)

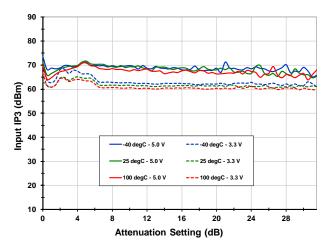
Phase vs. Frequency



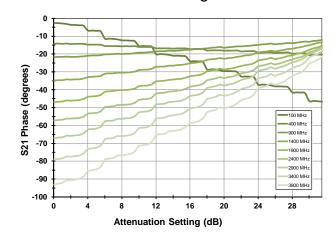
Supply Current IDD



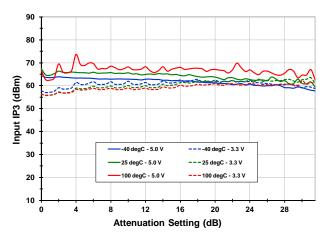
Input IP3 [f_{RF} = 1900 MHz]



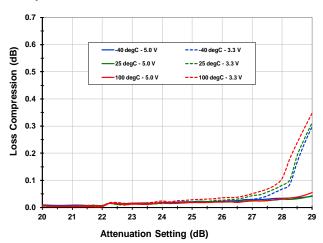
Phase vs. Attenuation Setting



Input IP3 [f_{RF} = 900 MHz]

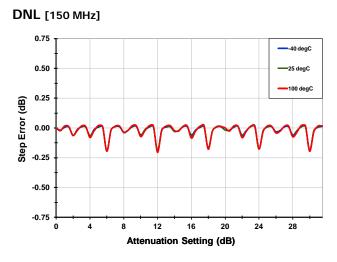


Compression [f_{RF} = 2000 MHz, ATTN = 2.5 dB]

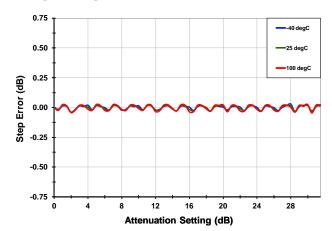


F1951 Datasheet

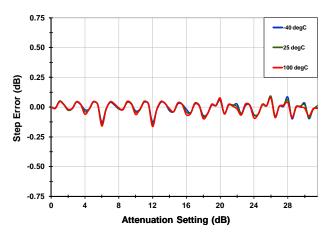
TOCs CONTINUED (-3-)

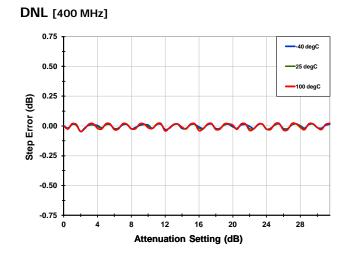


DNL [900 MHz]

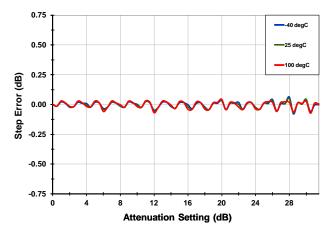


DNL [2800 MHz]

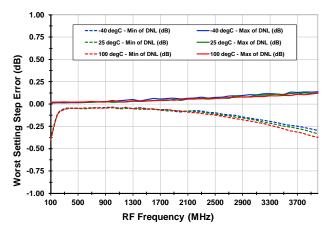






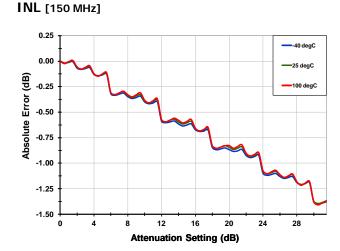




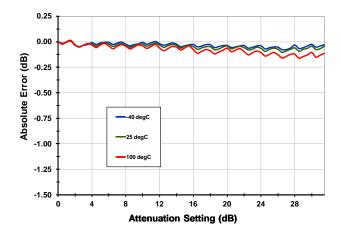




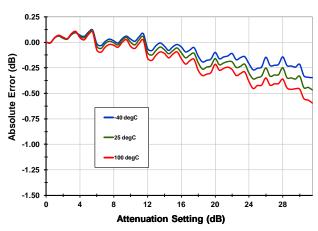
TOCs CONTINUED (-4-)

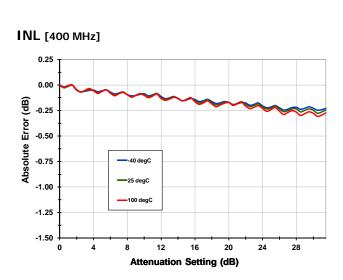


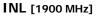
INL [900 MHz]

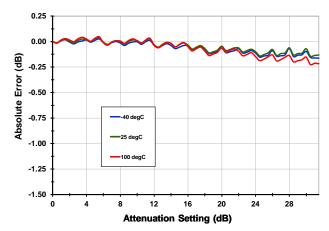




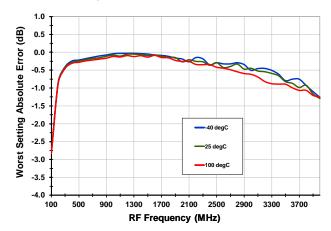




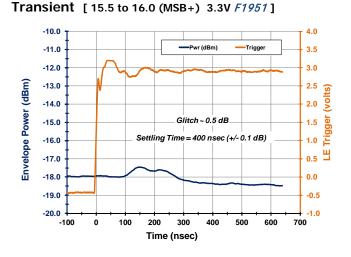






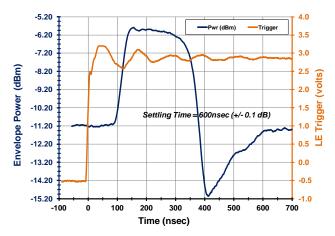


TOCS CONTINUED (-5-) [f_{RF} = 900 MHz]

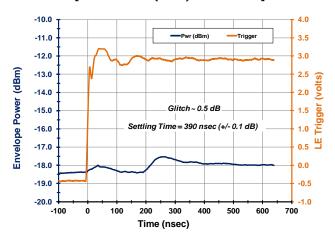


The graphs ABOVE show the transient overshoot and settling time performance for both the MSB+ and MSB-cases for the F1951. The device settles very quickly (~400 ns) with benign (~0.5 dB) overshoot.

Transient [15.75 to 16.00 (MSB+) Standard DSA]

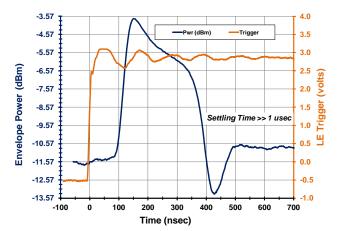


Transient [16.0 to 15.5 (MSB-) 5.0V F1951]

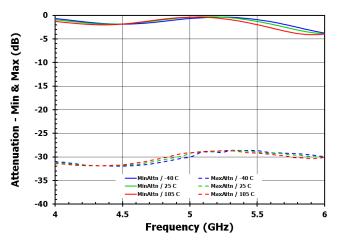


The graphs BELOW show the transient overshoot and settling time performance for a popular competing DSA. *Note the overshoot/undershoot excursion of almost 10 dB* and the very long settling time. For the MSB- case, the settling time is off the scale, $\sim 3 \ \mu s$.

Transient [16.00 to 15.75 (MSB-) Standard DSA]

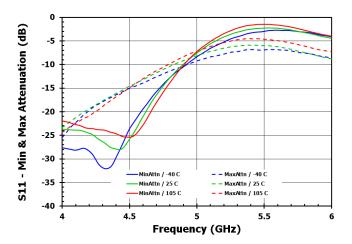


TOCs CONTINUED (-6-)

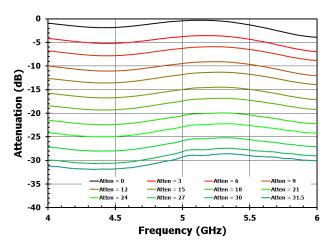


Insertion Loss – HB [Max & Min Attenuations]





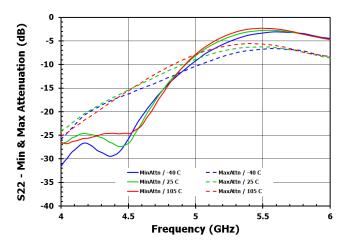
Insertion Loss Vs. Attenuation States [25C]



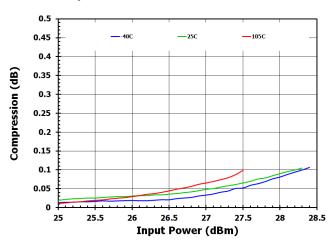
90 40 S21 Phase (deg) -10 -60 -110 -160 4.1GHz / -40C 4.3GHz / -40C 5GHz / -40C – 4.1GHz / 250 4.3GHz / 250 • 5GHz / 250 – – 4.1GHz / 105C – 4.3GHz / 105C • • • 5GHz / 105C -210 5 10 15 20 25 30 0 Attenuation (dB)

Phase Vs. Attenuation [4GHz to 4.3GHz]

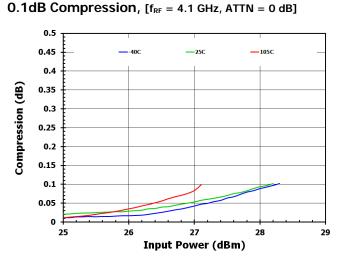
RF2 Return Loss – HB [Max & Min Attenuations]



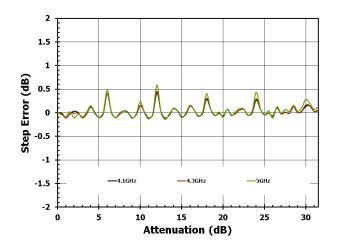
0.1dB Compression, $[f_{RF} = 3.9 \text{ GHz}, \text{ATTN} = 0 \text{ dB}]$



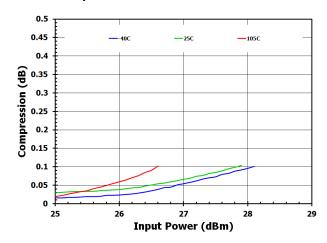
TOCs CONTINUED (-7-)



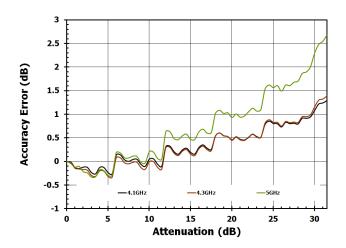
Step Error DNL [25C]



0.1dB Compression, $[f_{RF} = 4.3 \text{ GHz}, \text{ATTN} = 0 \text{ dB}]$





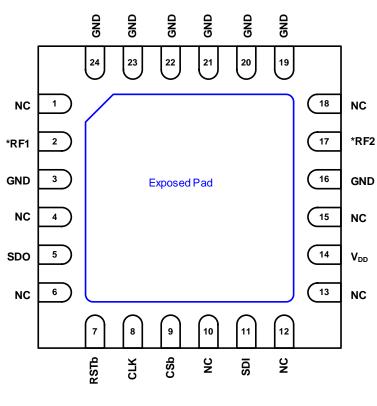




F1951 Datasheet

PIN DIAGRAM

TOP View (looking through the top of the package)



* Device is RF Bi-Directional

PACKAGE OUTLINE DRAWING (4x4MM, 24 PIN)

The package outline drawings are appended at the end of this document and are accessible from the link below. The package information is the most current data available.

https://www.renesas.com/us/en/document/psc/24-vfqfpn-package-outline-drawing-40-x-40-x-075-mm-body-05mm-pitch-epad-26-x-26-mm-nbnbg24p2



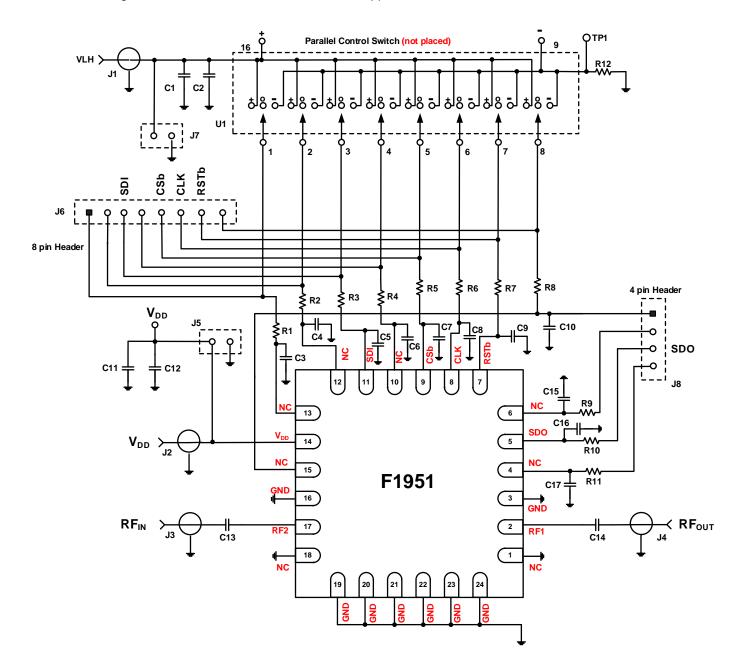
PIN DESCRIPTIONS

| Pin # | Pin Name | Pin Function |
|-------|-------------------|--|
| 1 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 2 | RF1 | Device RF input or output (bi-directional). Requires a DC Block. |
| 3 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| 4 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 5 | SDO | Serial Data Out. Delayed 8 clock cycles from Serial Data In. |
| 6 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 7 | RSTb | Reset BAR. Falling Edge resets the device to Max Attenuation [D5:D0] = [000000]. |
| 8 | CLK | Serial Clock. |
| 9 | CSb | Chip Select Bar. Serial Data latched into active register on Rising Edge. |
| 10 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 11 | SDI | Serial Data Input. |
| 12 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 13 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 14 | VDD | Main Supply. Use 3.3V or 5V. Current is < 1 mA. |
| 15 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 16 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| 17 | RF2 | Device RF output or input (bi-directional). Requires a DC Block. |
| 18 | NC | No internal connection. These pins can be left unconnected, voltage applied, or connected to ground (recommended). |
| 19 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| 20 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| 21 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| 22 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| 23 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| 24 | GND | Connect directly to paddle ground or as close as possible to pin with thru via. |
| EP | Exposed Paddle | Connect to Ground with multiple vias for good thermal relief. |



EVKIT SCHEMATIC

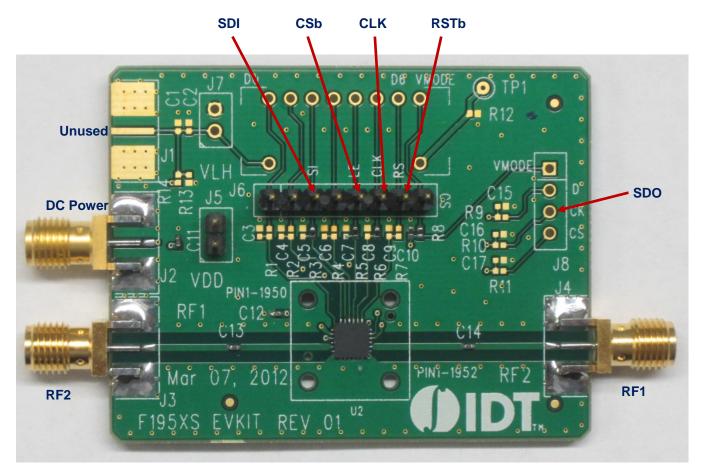
The diagram below describes the recommended applications / EVKit circuit:



EVKIT OPERATION

The figure below shows the connections for operating the EVKit.

Please note that the RF ports (RF1 and RF2) labels on the evaluation board are reversed. The evaluation board is used for multiple devices.



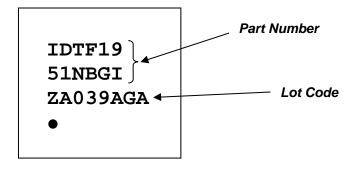
EVKIT BOM

| F1951 | BOM Rev 02 PCB F | Rev 01 | 10/26/20 |)12 |
|-------|------------------|--------|----------|-----|
| | | | | |

| ltem # | Value | Size | Description | Mfr. Part # | Mfr. | Ref Des | Qty |
|--------|-------------------------|------|----------------------------------|---------------------|-----------------|---------|-----|
| 1 | 1000pF | 0402 | CAP CER 1000PF 50V C0G 0402 | GRM1555C1H102JA01D | MURATA | C13,14 | 2 |
| 2 | 10nF | 0402 | CAP CER 10000PF 16V 10% X7R 0402 | GRM155R71C103KA01D | MURATA | C12 | 1 |
| 3 | 0.1uF | 0402 | CAP CER 0.1UF 16V 10% X7R 0402 | GRM155R71C104KA88D | MURATA | C11 | 1 |
| 4 | Header 2 Pin | TH 2 | CONN HEADER VERT SGL 2POS GOLD | 961102-6404-AR | ЗМ | J5 | 1 |
| 5 | Header 4 Pin | TH 4 | CONN HEADER VERT SGL 4POS GOLD | 961104-6404-AR | 3M | J8 | 1 |
| 6 | Header 8 Pin | TH 8 | CONN HEADER VERT SGL 8POS GOLD | 961108-6404-AR | 3M | J6 | 1 |
| 7 | SMA_END_LAUNCH | .062 | SMA_END_LAUNCH (Small) | 142-0711-821 | Emerson Johnson | J2,3,4 | 3 |
| 8 | 0 | 0402 | RES 0.0 OHM 1/10W 0402 SMD | ERJ-2GE0R00X | Panasonic | R7,8,10 | 3 |
| 9 | ЗК | 0402 | RES 3.00K OHM 1/10W 1% 0402 SMD | ERJ-2RKF3001X | Panasonic | R3,5,6 | 3 |
| 10 | Digital Step Attenuator | | F1951 | F1951 | IDT | U2 | 1 |
| 11 | РСВ | | PCB Rev 01 | F195XS Evkit Rev 01 | | | 1 |

Total 18

TOP MARKING



EVKIT THROUGH-REFLECT-LINE (TRL) CALIBRATION

RENESAS

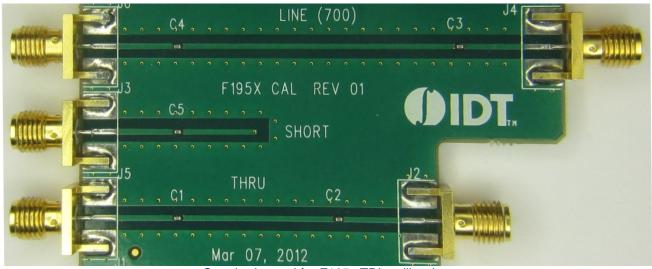
The "Through-Reflect-Line" (TRL) method [1] is used to de-embed the evaluation board losses from the S-parameter measurements of the F1951. This method requires the use of three standards: a through, a reflection, and a line. The TRL method has the advantage over other calibration methods in that it requires only one of these three standards to be well defined.

The TRL through which is used for the F1951 TRL calibration was constructed identically to the evaluation board, minus the DUT and its corresponding length. Therefore, the through corresponds to a precise zero length connection between the input and output reference planes of the DUT. This through satisfies the requirement of the TRL method that one of the three standards be precisely specified.

The TRL reflection standard used is constructed identically to the input and output lines of the evaluation board, with a short placed at the reference plane of the DUT. In accordance with the TRL method's requirements, the actual magnitude and phase were not accurately specified, but the phase was known to within 90 degrees and the TRL reflection standard has a magnitude close to one.

The TRL line standard is identical to the TRL through, but with an additional length of 0.8 inches (2 cm). This satisfies the TRL method's requirement that the TRL be a different length than the TRL through, that it have the same impedance and propagation constant as the through, and that the phase difference between the through and the line be between 20 degrees and 160 degrees. The difference in length yields a phase difference of approximately 20 degrees at 500 MHz, and a phase difference of 160 degrees at 4 GHz.

For characterization of performance from 150 to 500 MHz a separate TRL board with different "Line" length is used.



Standards used for F195x TRL calibration



F1951 evaluation circuit

[1] Engen, G.F.; Hoer, C.A.; "Thru-Reflect-Line: An Improved Technique for Calibrating the Dual Six-Port Automatic Network Analyzer," IEEE Transactions on Microwave Theory and Techniques, Volume: 27 Issue:12, pp. 987 – 993, Dec 1979.



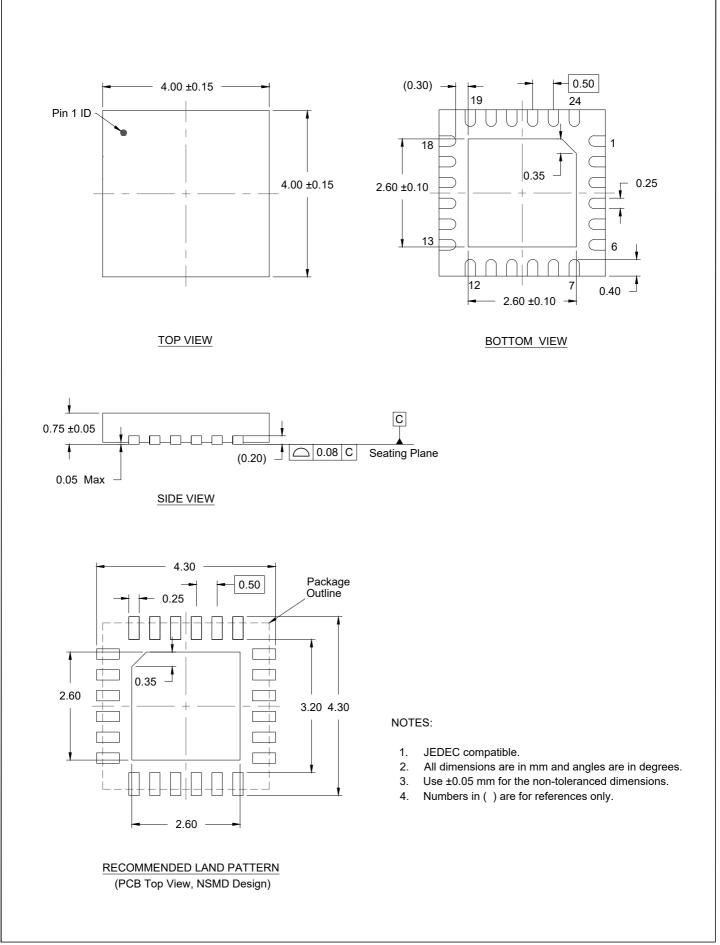
REVISION HISTORY

| Rev | Date | Description of Change |
|-----|--------------------|---|
| 6 | September 28, 2021 | Updated Top Marking Diagram with correct information Completed other minor changes |
| 5 | August 7, 2020 | Updated Operating Range to 5GHz, Updated High Frequency Plots |
| 4 | May 10, 2018 | Removed maximum spec for CSb timing. Revision of voltage supply range on page 1 to match specification table. Revision of the package outline drawing (POD) section to explain that the POD is now given at the end of the document and to provide a link to the POD on the company website. POD is now NBG24P2. Revision of references to part name from IDTF1951 to F1951. Minor edits. |
| 3 | July 21, 2017 | Corrected Absolute Maximum Supply Voltage. Added information about Serial Output Line. Added Revision History Sheet |
| 2 | Apil 02, 2014 | Corrected Timing Decriptions |
| 1 | March 20, 2013 | Corrected Footer |
| 0 | January 15, 2013 | Initial Release |



Package Outline Drawing

Package Code:NBG24P2 24-VFQFPN 4.0 x 4.0 x 0.75 mm Body, 0.50 mm Pitch PSC-4313-02, Revision: 03, Date Created: Jul 20, 2023



IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD-PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers who are designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only to develop an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third-party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising from your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.01)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit <u>www.renesas.com/contact-us/</u>.